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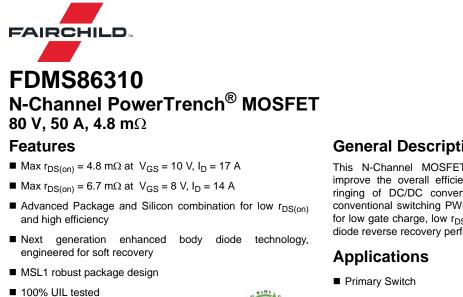


# **ON Semiconductor**®

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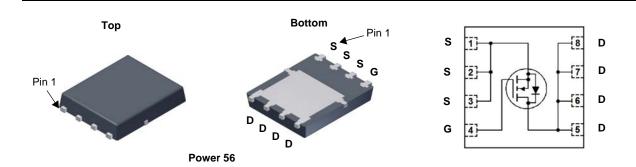
RoHS Compliant



## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{\text{DS(on)}}$ , fast switching speed and body diode reverse recovery performance.

- Synchronous Rectifier
- Motor Switch



### **MOSFET Maximum Ratings** $T_A = 25$ °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			80	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		50		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		105		
ID	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	17	Α	
	-Pulsed			100		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	183	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		96	14/	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.3	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86310	FDMS86310	Power 56	13 "	12 mm	3000 units

October 2014

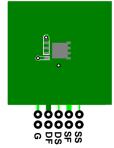
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	80			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		45		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.4	3.3	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A		3.8	4.8	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 8 V, I <sub>D</sub> = 14 A		4.5	6.7	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A, T <sub>J</sub> = 125 °C		5.7	7.2	
Dynamic	Forward Transconductance Characteristics	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$		49		S
-	Characteristics			ļ	6200	
<b>Dynamic</b> C <sub>iss</sub>		$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ 		49 4730 693	6290 925	S pF pF
Dynamic	Characteristics	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 17 A		4730		pF
Dynamic C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ 		4730 693	925	pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ 		4730 693 19	925	pF pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchin	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ 		4730 693 19	925	pF pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1  MHz		4730 693 19 1.3	925 45	pF pF pF Ω
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ Switchin $t_{d(on)}$ $t_r$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ 		4730 693 19 1.3 28	925 45 45	pF pF pF Ω ns
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchin	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1  MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 17 \text{ A},$		4730 693 19 1.3 28 23	925 45 45 45 37	pF pF pF Ω ns
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ Switchin $t_{a(on)}$ $t_r$ $t_{d(off)}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1  MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 17 \text{ A},$		4730 693 19 1.3 28 23 35	925 45 45 45 37 56	pF pF pF Ω ns ns
$\begin{array}{c} \textbf{Dynamic} \\ \textbf{C}_{iss} \\ \textbf{C}_{oss} \\ \textbf{C}_{rss} \\ \textbf{R}_{g} \\ \textbf{Switchin} \\ \textbf{t}_{d(on)} \\ \textbf{t}_{r} \\ \textbf{t}_{d(off)} \\ \textbf{t}_{f} \end{array}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 8 \text{ V}$ $V_{DD} = 40 \text{ V},$		4730 693 19 1.3 28 23 35 9	925 45 45 37 56 18	pF pF Ω ns ns ns ns
$\begin{array}{c} \textbf{Dynamic} \\ \hline \textbf{C}_{iss} \\ \hline \textbf{C}_{rss} \\ \hline \textbf{C}_{rss} \\ \hline \textbf{R}_{g} \\ \hline \textbf{Switchin}_{t} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Q}_{g} \\ \hline \end{array}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance  Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		4730 693 19 1.3 28 23 35 9 66	925 45 45 37 56 18 95	pF pF pF Ω ns ns ns ns ns

Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$	(Note 2)	0.72	1.2	V
	Source to Drain Diode Porward Voltage	$V_{GS} = 0 V, I_{S} = 17 A$	(Note 2)	0.81	1.3	v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 17 A, di/dt = 100 A/μs		51	80	ns
Q <sub>rr</sub>	Reverse Recovery Charge			41	65	nC
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 17 A, di/dt = 300 A/μs		43	69	ns
Q <sub>rr</sub>	Reverse Recovery Charge			87	140	nC

Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



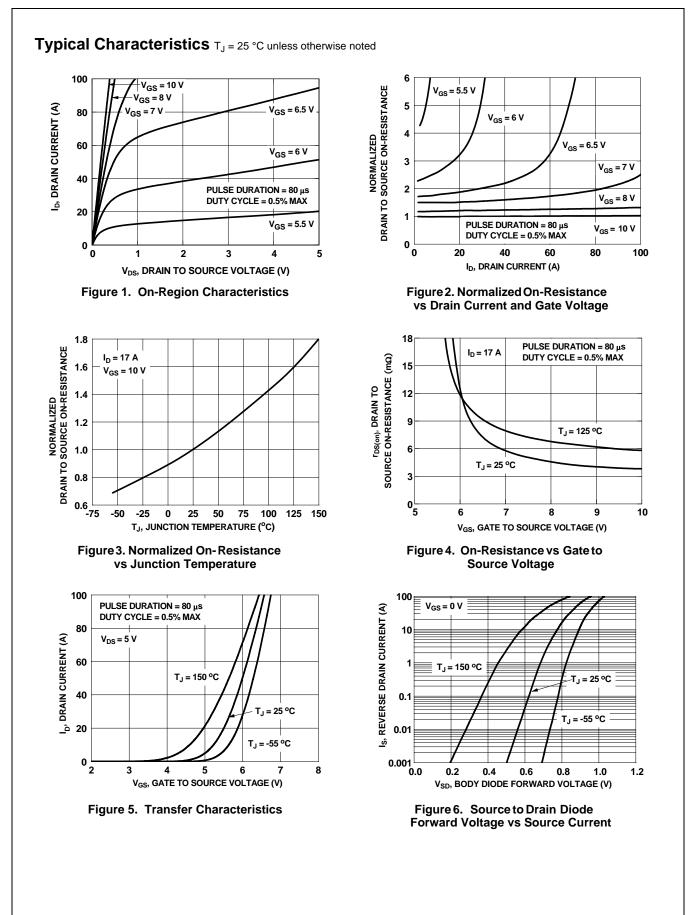
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

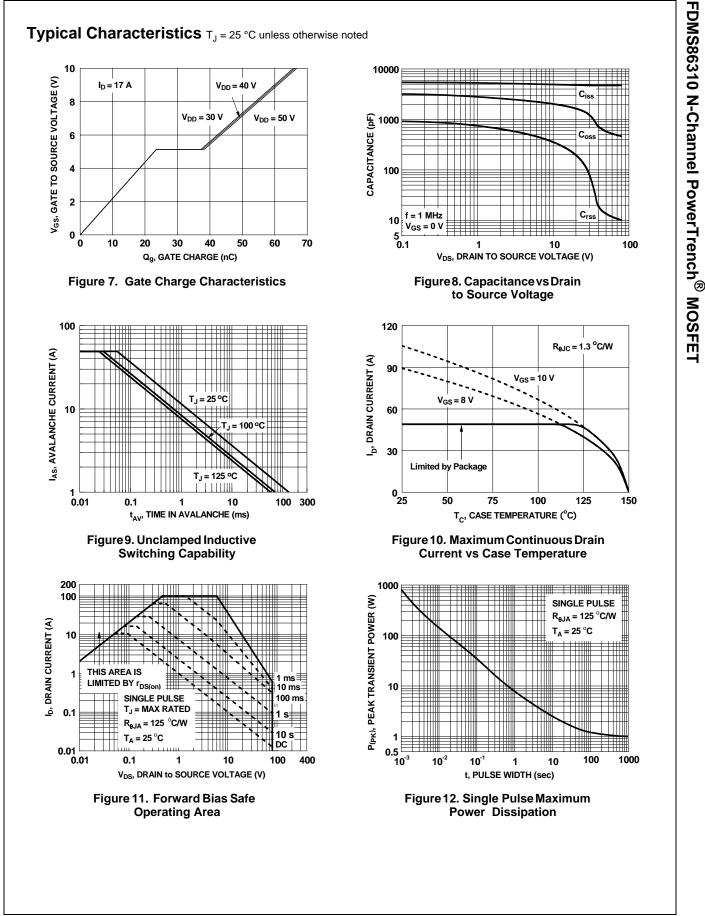
3. Starting T\_J = 25 °C, L = 0.3 mH, I\_{AS} = 35 A, V\_DD = 72 V, V\_{GS} = 10 V.

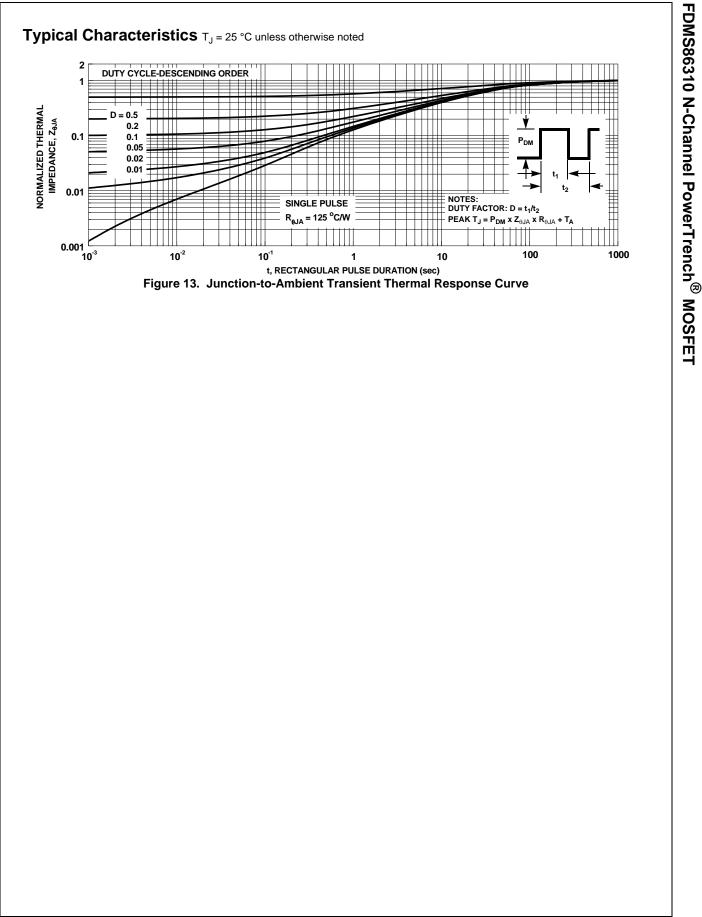


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b) 125 °C/W when mounted on a minimum pad of 2 oz copper.









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